()	Preliminary Specification
(V)	Final Specification

Module	19.0" Color TFT-LCD
Model Name	M190ETN01.0 (ES 7.0 from 00D)

Customer Date	Approved by	Date
	Howard Lee	Oct. 17, 2016
Approved by	Prepared by	Date
	<u>Kevin Su</u>	Oct. 15, 2016
Note: This Specification is subject to change without notice.	AU Optronic	s corporation



M190ETN01.0

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Contents

1 I	Handling Precautions	4
	General Description	
	2.1 Display Characteristics	
	2.2 Absolute Maximum Rating of Environment	6
	2.3 Optical Characteristics	7
	2.4 Mechanical Characteristics	12
3 7	TFT-LCD Module	13
	3.1 Block Diagram	13
	3.2 Interface Connection	14
	3.2.1 Connector Type	14
	3.2.2 Connector Pin Assignment	14
	3.3 Electrical Characteristics	16
	3.3.1 Absolute Maximum Rating	16
	3.3.2 Recommended Operating Condition	16
	3.4 Signal Characteristics	17
	3.4.1 LCD Pixel Format	
	3.4.2 LVDS Data Format	
	3.4.3 Color versus Input Data	
	3.4.4 LVDS Specification	
	3.4.5 Input Timing Specification	
	3.4.6 Input Timing Diagram	
	3.5 Power ON/OFF Sequence	
	Backlight Unit	
	4.1 Block Diagram	
	4.2 Interface Connection	
	4.2.1 Connector Type	
	4.2.2 Connector Pin Assignment	
	4.3 Electrical Characteristics	
	4.3.1 Absolute Maximum Rating	
	4.3.2 Recommended Operating Condition	
	Reliability Test	
	Shipping Label	
	Mechanical Characteristics	
	Packing Specification	
	8.1 Packing Flow	
	8.2 Pallet and shipment information	34



M190ETN01.0

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Record of Revision

Version	Date	Page	Old description	New Description	Remark
V 0.0	2016/03/02	All	Frist Edition for Customer		
V1.0	2016/10/20	All		Final Spec.	



M190ETN01.0

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1 Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open or modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) In case a TFT-LCD Module has to be put back into the packing container slot after once it was taken out from the container, do not press the center of the LED lightbar edge. Otherwise the TFT-LCD Module may be damaged.
- 10) Insert or pull out the interface connector, be sure not to rotate nor tilt it of the TFT-LCD Module.
- 11) Do not twist nor bend the TFT -LCD Module even momentary. It should be taken into consideration that no bending/twisting forces are applied to the TFT-LCD Module from outside. Otherwise the TFT-LCD Module may be damaged.
- 12) Please avoid touching COF position while you are doing mechanical design.
- 13) When storing modules as spares for a long time, the following precaution is necessary: Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5°C and 35°C at normal humidity.



2 General Description

This specification applies to the 19 inch SXGA Color a-Si TFT-LCD Module M190ETN01.0. The display supports the SXGA -1280(H) x 1024(V) screen format and 16.7M colors (8bits RGB data input). The input interface is Dual channel LVDS and this module doesn't contain an driver board for backlight.

2.1 Display Characteristics

The following items are characteristics summary on the table under 25 ℃ condition:

ITEMS	Unit	SPECIFICATIONS
Screen Diagonal	[mm]	482.6 (19.0")
Active Area	[mm]	376.32 (H) x 301.056 (V)
Pixels H x V	-	1280(x3) x 1024
Pixel Pitch	[um]	294 (per one triad) ×294
Pixel Arrangement	-	R.G.B. Vertical Stripe
Display Mode	-	TN Mode, Normally White
White Luminance (Center)	[cd/m ²]	250 (Typ.) @ 50.0mA
Contrast Ratio	-	1000 (Typ.)
Response Time	[msec]	5 (Typ., on/off)
Power Consumption	[Watt]	9.4 (Typ.)
(LCD Module + Backligh unit)		LCD module : PDD (Typ.)=2.7 @ Black pattern,Fv=60Hz
		Backlight unit : P _{BLU} (Typ.) =6.6
Weight	[Grams]	1700
Outline Dimension	[mm]	396(H) × 324(V) × 10.9(D) Typ.
Electrical Interface	-	Dual channel LVDS 8bits RGB data input
Support Color	-	16.7M colors
Surface Treatment	-	Anti-Glare, 3H
Temperature Range		
Operating	[°C]	0 to +50
Storage (Shipping)	[°C]	-20 to +60
RoHS Compliance	-	RoHS Compliance
TCO Compliance	-	TCO 7.0 Compliance



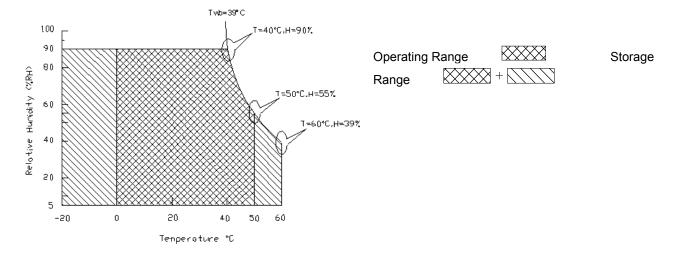
2.2 Absolute Maximum Rating of Environment

Permanent damage may occur if exceeding the following maximum rating.

Symbol	Description	Min.	Max.	Unit	Remark
TOP	Operating Temperature	0	+50	[°C]	Note 2-1
TGS	Glass surface temperature (operation)	0	+65	[°C]	Note 2-1 Function judged only
HOP	Operation Humidity	5	90	[%RH]	Note 2-1
TST	Storage Temperature	-20	+60	[°C]	
HST	Storage Humidity	5	90	[%RH]	

Note 2-1: Temperature and relative humidity range are shown as the below figure.

- 1. 90% RH Max (Ta \leq 39 $^{\circ}$ C)
- 2. Max wet-bulb temperature at 39°C or less. (Ta \leq 39°C)
- 3. No condensation



2.3 Optical Characteristics

The optical characteristics are measured on the following test condition.

Test Condition:

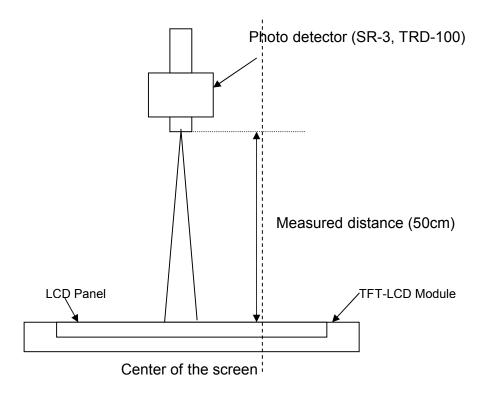
1. Equipment setup: Please refer to Note 2-2.

2. Panel Lighting time: 30 minutes

3. VDD=5.0V, Fv=60Hz,Is=55mA,Ta=25 $^{\circ}$ C

Symbol	Descriptio	n	Min.	Тур.	Max.	Unit	Remark
L _w	White Luminance (Cen	200	250		[cd/m2]	Note 2-2	
-w	vviiko Edilinidrioo (Oori	200	250	-	[ca/ma]	By SR-3	
L_{uni}	Luminance Uniformit	v (9 noints)	75	80	_	[%]	Note 2-3
-uiii	Editination Officiality	y (o pointo)					By SR-3
CR	Contrast Ratio (Cente	er of screen)	600	1000	-	-	Note 2-4
							By SR-3
θ_{R}	Horizontal Viewing Angle	Right	75	85	-		
θ_{L}	(CR=10)	Left	75	85	-		
Φ_{H}	Vertical Viewing Angle	Up	70	80	-		
$\Phi_{\scriptscriptstyle m L}$	(CR=10)	Down	70	80	-	[degree]	Note 2-5
θ_{R}	Horizontal Viewing Angle	Right	75	88	-		By SR-3
θ_{L}	(CR=5)	Left	75	88	ı		
Φ_{H}	Vertical Viewing Angle	Up	70	85	-		
$\Phi_{ t L}$	(CR=5)	Down	70	85	-		
T_R		Rising Time	-	3.6	5.7	[msec]	
T_F	Response Time	Falling Time	-	1.4	2.3		Note 2-6
-		Rising + Falling	-	5	8		By TRD-100
R _x		Red x	0.617	0.647	0.677		
R _y		Red y	0.311	0.341	0.371		
G _x		Green x	0.296	0.326	0.356		
Gy	Color Coordinates	Green y	0.596	0.626	0.656		
B _x	(CIE 1931)	Blue x	0.122		0.182	-	By SR-3
Ву		Blue y	0.025			1	
W _x		White x	0.283	0.313	0.343		
W _y		White y	0.299	0.329	0.359		
						F0/ 1	Note 2-7
СТ	Crosstalk		-	-	1.5	[%]	By SR-3
F _{dB}	Flicker (Center of	screen)	-	-	-20	[dB]	Note 2-8 By SR-3

Note 2-2: Equipment setup :



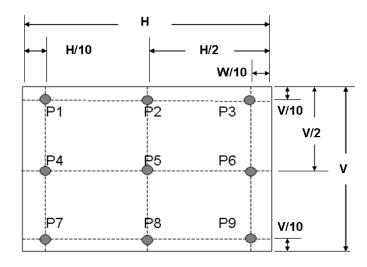
Note 2-3: Luminance Uniformity Measurement

Definition:

 $Luminance\ Uniformity = \frac{Minimum\ Luminance\ of\ 9\ Points\ (P1\sim P9)}{Maximum\ Luminance\ of\ 9\ Points\ (P1\sim P9)}$

a. Test pattern: White Pattern





Note 2-4: Contrast Ratio Measurement

Definition:

Contrast Ratio = Luminance of White pattern

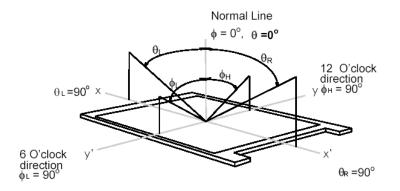
Luminance of Black pattern

a. Measured position: Center of screen (P5) & perpendicular to the screen $(\theta=\Phi=0^{\circ})$

Note 2-5: Viewing angle measurement

Definition: The angle at which the contrast ratio is greater than 10 & 5.

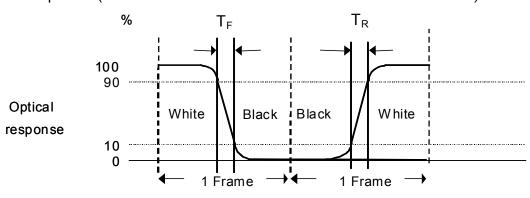
a. Horizontal view angle: Divide to left & right ($\theta_L \& \theta_R$) Vertical view angle: Divide to up & down ($\Phi_H \& \Phi_L$)



Note 2-6: Response time measurement



The output signals of photo detector are measured when the input signals are changed from "Black" to "White" (rising time, T_R), and from "White" to "Black" (falling time, T_F), respectively. The response time is interval between the 10% and 90% of optical response. (Black & White color definition: Please refer section 3.4.3)





Note 2-7: Crosstalk measurement

Definition:

 $CT = Max. (CT_H, CT_V);$

Where

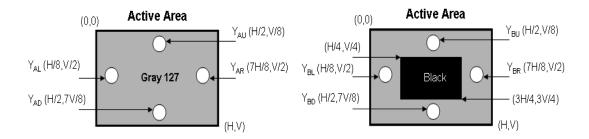
a. Maximum Horizontal Crosstalk:

$$CT_{H} = Max. \; (\mid Y_{BL} - Y_{AL} \mid / \; Y_{AL} \times \; 100 \; \%, \; \mid Y_{BR} - Y_{AR} \mid / \; Y_{AR} \times \; 100 \; \%);$$

Maximum Vertical Crosstalk:

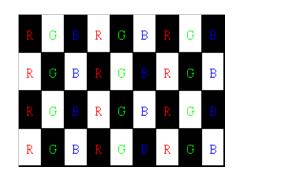
$$CT_V = Max. (|Y_{BU} - Y_{AU}|/Y_{AU} \times 100 \%, |Y_{BD} - Y_{AD}|/Y_{AD} \times 100 \%);$$

b. Y_{AU} , Y_{AD} , Y_{AL} , Y_{AR} = Luminance of measured location without Black pattern Y_{BU} , Y_{BD} , Y_{BL} , Y_{BR} = Luminance of measured location with Black pattern



Note 2-8: Flicker measurement

a. Test pattern: It is listed as following.



Gray level = L0

Gray level = L127

R: Red, G: Green, B:Blue

b. Measured position: Center of screen (P5) & perpendicular to the screen ($\theta=\Phi=0^{\circ}$)



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2.4 Mechanical Characteristics

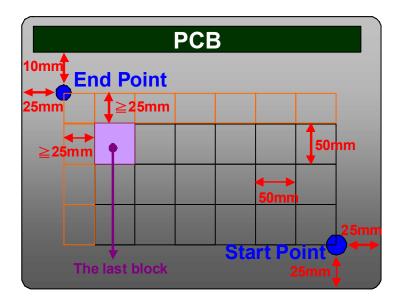
Symbol	Description	Min.	Max.	Unit	Remark
P _{bc}	Backside Compression	2.5	-	[Kgf]	Note 2-9

Note 2-9: Test Method:

The point is at a distance from right-downside 25mm x 25mm defined as the Start Point of Measure Points, and the point is at a distance 25mm from left-side & around 10mm from PCB defined as the End Point.

Align 50mm x 50mm block from Start Point on the Bezel Back, and the corners of each block are Measure Points.

If the distance from the last block to each side of the End Point \geq 25mm, add other blocks to make sure that most area of Bezel Back can be measured.

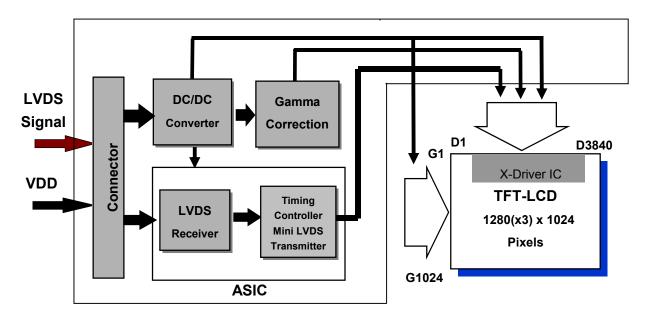




3 TFT-LCD Module

3.1 Block Diagram

The following shows the block diagram of the 19.0 inch Color TFT-LCD Module.



Control Board



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3.2 Interface Connection

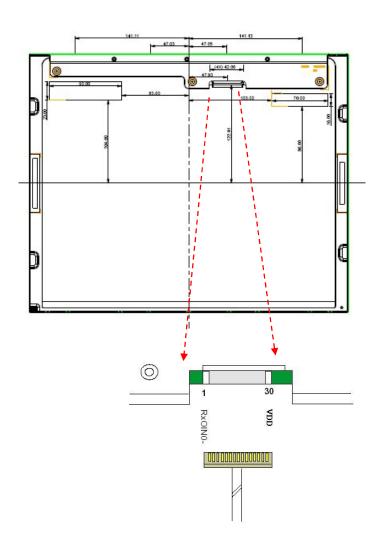
3.2.1 Connector Type

TFT-LCD Connector	Manufacturer	P-TWO	STM	
TI I-LOD CONNECTOR	Part Number	187034-3009 MSBKT2407P30		
	Manufacturer	JAE		
Mating Connector	Part Number	FI-X30HL		
	Part Number	FI-X30H (Unlocked Type)		

3.2.2 Connector Pin Assignment

PIN#	Symbol	Description	Remark
1	RxOIN0-	Negative LVDS differential data input (Odd data)	
2	RxOIN0+	Positive LVDS differential data input (Odd data)	
3	RxOIN1-	Negative LVDS differential data input (Odd data)	
4	RxOIN1+	Positive LVDS differential data input (Odd data)	
5	RxOIN2-	Negative LVDS differential data input (Odd data)	
6	RxOIN2+	Positive LVDS differential data input (Odd data)	
7	GND	Power Ground	
8	RxOCLKIN-	Negative LVDS differential clock input (Odd clock)	
9	RxOCLKIN+	Positive LVDS differential clock input (Odd clock)	
10	RxOIN3-	Negative LVDS differential data input (Odd data)	
11	RxOIN3+	Positive LVDS differential data input (Odd data)	
12	RxEIN0-	Negative LVDS differential data input (Even data)	
13	RxEIN0+	Positive LVDS differential data input (Even data)	
14	GND	Power Ground	
15	RxEIN1-	Positive LVDS differential data input (Even data)	
16	RxEIN1+	Negative LVDS differential data input (Even data)	
17	GND	Power Ground	
18	RxEIN2-	Negative LVDS differential data input (Even data)	
19	RxEIN2+	Positive LVDS differential data input (Even data)	
20	RxECLKIN-	Negative LVDS differential clock input (Even clock)	
21	RxECLKIN+	Positive LVDS differential clock input (Even clock)	
22	RxEIN3-	Negative LVDS differential data input (Even data)	
23	RxEIN3+	Positive LVDS differential data input (Even data)	
24	GND	Power Ground	
25	GND	NC & Power Ground	
26	NC	No connection (for AUO test)	

27	NC	No connection (for AUO test)	
28	POWER	Power +5V	
29	POWER	Power +5V	
30	POWER	Power +5V	





3.3 Electrical Characteristics

3.3.1 Absolute Maximum Rating

Permanent damage may occur if exceeding the following maximum rating.

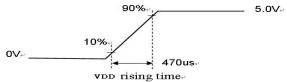
Symbol	Description	Min	Max	Unit	Remark
VDD	Power Supply Input Voltage	GND-0.3	6.0	[Volt]	Ta=25°C

3.3.2 Recommended Operating Condition

Symbol	Description	Min	Тур	Max	Unit	Remark
VDD	Power supply Input voltage	4.5	5.0	5.5	[Volt]	
IDD	Power supply	ı	0.53	0.64	[A]	VDD= 5.0V, Black Pattern, Fv=60Hz
טטו	Input Current (RMS)		0.61	0.73	[A]	VDD= 5.0V, Black Pattern, Fv=75Hz
PDD	VDD Power	ı	2.7	3.2	[Watt]	VDD= 5.0V, Black Pattern, Fv=60Hz
	Consumption		3.05	3.7	[Watt]	VDD= 5.0V, Black Pattern, Fv=75Hz
IRush	Inrush Current	-	-	3.0	[A]	Note 3-1
VDDrp	Allowable VDD Ripple Voltage	-	-	500	[mV]	VDD= 5.0V, Black Pattern, Fv=75Hz

Note 3-1: Inrush Current measurement:

Test circuit: (High to Low) (Nigh to Low) (Nigh to Low) (LCD Module Input) (Nigh to Low) (

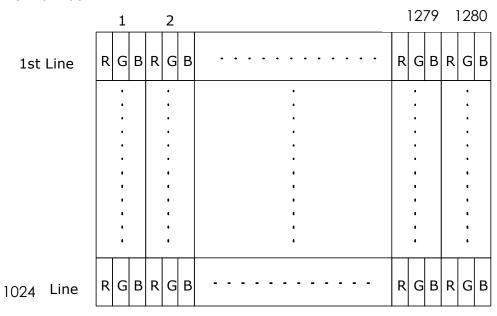


The duration of VDD rising time: 470us.

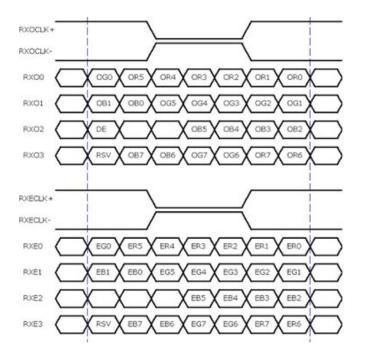


3.4 Signal Characteristics

3.4.1 LCD Pixel Format



3.4.2 LVDS Data Format



8 Bit Color Bit Order									
MSB	R7	G7	B7						
	R6	G6	B6						
	R5	G5	B5						
	R4	G4	B4						
	R3	G3	В3						
	R2	G2	B2						
	R1	G1	B1						
LSB	R0	G0	B0						

Note 3-2:

- a. O = "Odd Pixel Data" E = "Even Pixel Data"
- b. Refer to 3.4.1 LCD pixel format, the 1st data is 1 (Odd Pixel Data), the 2nd data is 2 (Even Pixel Data) and the last data is 1280 (Even Pixel Data).

3.4.3 Color versus Input Data

The following table is for color versus input data (8bit). The higher the gray level, the brighter the color.

												Col	or Inp	out D	ata											
Color Gray Level	Gray Level	RED data (MSB:R7, LSB:R0)					GREEN data (MSB:G7, LSB:G0)				BLUE data (MSB:B7, LSB:B0)				Remark											
		R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	В7	В6	B5	B4	ВЗ	В2	B1	В0	
Black	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
White	-	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
Gray 127	-	0	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	
	Ω	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Red					•••	• • •	•••	***	:	:	:		:	:	:	:	:		•••	:	:	:	:	:	:	
	L255	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Ш	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Green	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L255	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	
	Ш	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Blue	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L255	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	



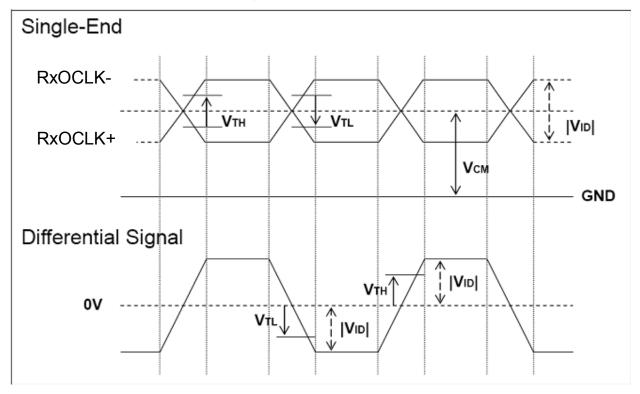
3.4.4 LVDS Specification

a. DC Characteristics:

Symbol	Description	Min	Тур	Max	Units	Condition
V _{TH}	LVDS Differential Input High Threshold	-	-	+100	[mV]	V _{CM} = 1.2V
V _{TL}	LVDS Differential Input Low Threshold	-100	-	ı	[mV]	V _{CM} = 1.2V
V _{ID}	LVDS Differential Input Voltage	100	-	600	[mV]	
V _{CM}	LVDS Common Mode Voltage	+1.0	+1.2	+1.5	[V]	V_{TH} - V_{TL} = 200mV

LVDS Signal Waveform:

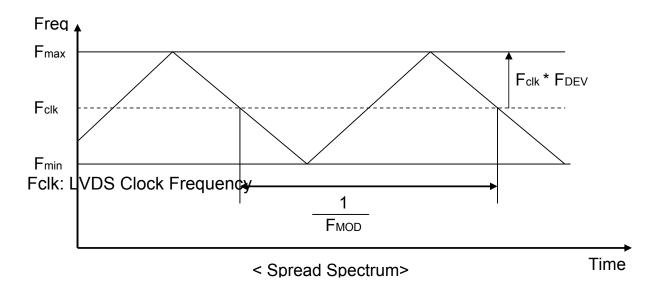
Use RxOCLK- & RxOCLK+ as example.



b. AC Characteristics:

Symbol Description Min Max Unit Remark
--

F _{DEV}	Maximum deviation of input clock frequency during Spread Spectrum	•	± 3	%	
F _{MOD}	Maximum modulation frequency of input clock during Spread Spectrum	1	200	KHz	





3.4.5 Input Timing Specification

It only support DE mode, and the input timing are shown as the following table.

Symbol	Descript	ion	Min.	Тур.	Max.	Unit	Remark
Tv		Period	1036	1066	1873	Th	
Tdisp (v)	Vertical Section	Active	1024	1024	1024	Th	
Tblk (v)		Blanking	12	42	849	Th	
Fv		Frequency	50	60	76	Hz	
Th		Period	730	844	1320	Tclk	
Tdisp (h)	Horizontal Section	Active	640	640	640	Tclk	
Tblk (h)		Blanking	90	204	680	Tclk	
Fh		Frequency	51.8	64	93.7	KHz	Note 3-3
Tclk	LVDS Clock	Period	14.6	18.5	26.4	ns	1/Fclk
Fclk		Frequency	37.8	54	68.4	MHz	Note 3-4

Note 3-3: The equation is listed as following. Please don't exceed the above recommended value.

Fh (Min.) = Fclk (Min.) / Th (Min.); Fh (Typ.) = Fclk (Typ.) / Th (Typ.);

Fh (Max.) = Fclk (Max.) / Th (Min.);

Note 3-4: The equation is listed as following. Please don't exceed the above recommended value.

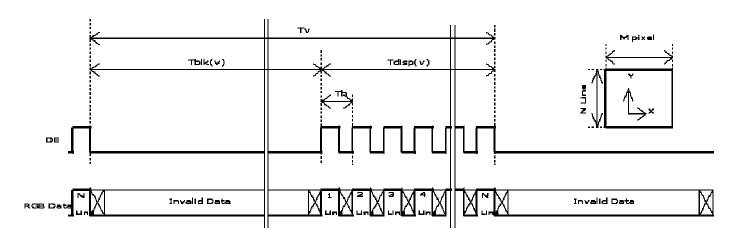
Fclk (Min.) = Fv (Min.) x Th (Min.) x Tv (Min.);

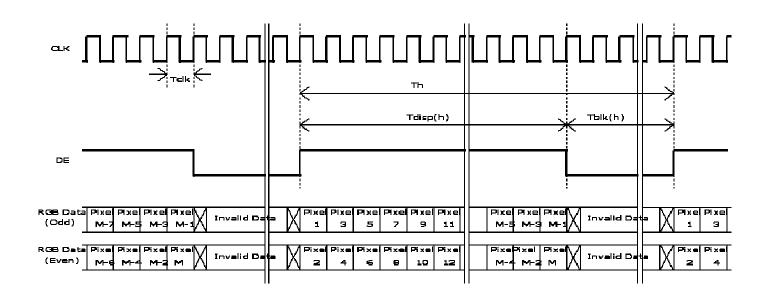
Fclk (Typ.) = Fv (Typ.) x Th (Typ.) x Tv (Typ.);

Fclk (Max.) = Fv (Max.) x Th (Typ.) x Tv (Typ.);



3.4.6 Input Timing Diagram

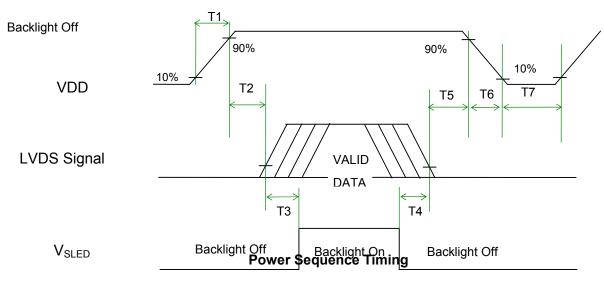






3.5 Power ON/OFF Sequence

VDD power,LVDS signal and backlight on/off sequence are as following. LVDS signals from any system shall be Hi-Z state when VDD is off.



Symbol		Value		11-4:4	Remark
Symbol	Min.	Тур.	Max.	Unit	
T1	0.5	-	10	[ms]	
T2	0	-	50	[ms]	
Т3	500	-	-	[ms]	
T4	100	-	-	[ms]	
T5	0		50	[ms]	Note 3-5 Note 3-6
T6	5	-	100	[ms]	Note 3-6
T7	1000	-	-	[ms]	

Note 3-5: Recommend setting T5 = 0ms to avoid electronic noise when VDD is off.

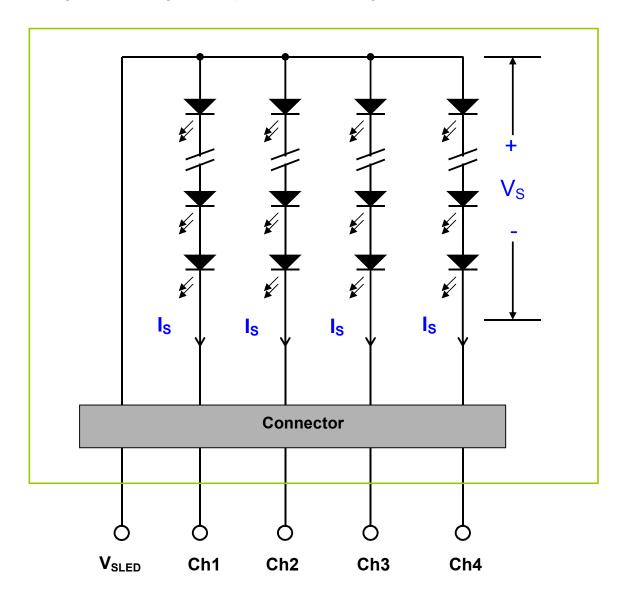
Note 3-6: During T5 and T6 period, please keep the level of input LVDS signals with Hi-Z state.



4 Backlight Unit

4.1 Block Diagram

The following shows the block diagram of the 19.0 inch Backlight Unit. And it includes 44 pcs LED in the LED light bar. (4 strings and 11 pcs LED of one string).





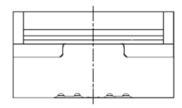
4.2 Interface Connection

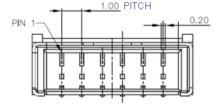
4.2.1 Connector Type

Backlight Connector	Manufacturer	ENTERY
Bushing it Connector	Part Number	3707K-S06N-21R
Mating Connector	Manufacturer	ENTERY
Mating Connector	Part Number	Non-Locking type: H112K-P06N-00B Locking type: H112K-P06N-03B

Backlight Connector dimension:

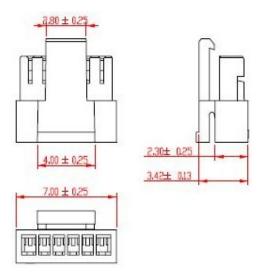
 $H \times V \times D = 13.9 \times 3.00 \times 4.25$, Pitch = 1.0(unit = mm)

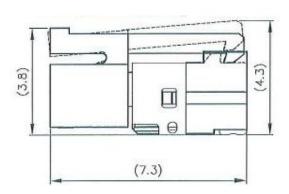






Mating Connector dimension:

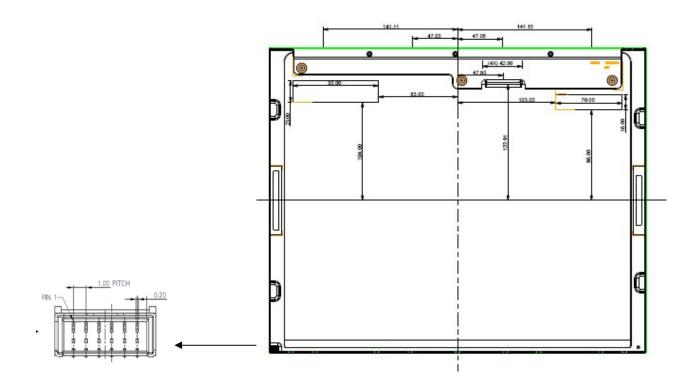






4.2.2 Connector Pin Assignment

Pin#	Symbol	Description	Remark
1	Ch1	LED Current Feedback Terminal (Channel 1)	
2	Ch2	LED Current Feedback Terminal (Channel 2)	
3	V_{SLED}	LED Power Supply Voltage Input Terminal	
4	V_{SLED}	LED Power Supply Voltage Input Terminal	
5	Ch3	LED Current Feedback Terminal (Channel 3)	
6	Ch4	LED Current Feedback Terminal (Channel 4)	



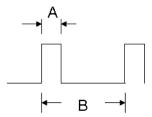
4.3 Electrical Characteristics

4.3.1 Absolute Maximum Rating

Permanent damage may occur if exceeding the following maximum rating.

(Ta=25°C)

Symbol	Description	Min	Max	Unit	Remark
			90	[mA]	100% duty ratio
Is	LED String Current	0	150	[mA]	Duty ratio ≦ 10% Pulse time=10 ms



Duty ratio= (A / B) X 100%; (A: Pulse time, B: Period)

4.3.2 Recommended Operating Condition

(Ta=25°€)

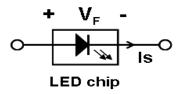
Symbol	Description	Min.	Тур.	Max.	Unit	Remark
Is	LED String Current	-	50	53	[mA]	100% duty ratio of LED chip, Note 4-6
Vs	LED String Voltage	30.8	33	37.4	[Volt]	Is=50mA @ 100% duty ratio; <i>Note 4-1, Note</i> 4-5, <i>Note 4-7</i>
ΔVs	Maximum Vs Voltage Deviation of light bar	-	-	0.44	[Volt]	Is=50mA @ 100% duty ratio; <i>Note 4-2</i>
P _{BLU}	LED Light Bar Power Consumption	-	6.6	7.48	[Watt]	Note 4-3
LT _{LED}	LED Life Time	30,000	-	-	[Hour]	Note 4-4
OVP	Over Voltage Protection in system board	110% Vs(max)	-	-	[Volt]	Note 4-5



M190ETN01.0

AU OPTRONICS CORPORATION

- **Note 4-1:** Vs (Typ.) = V_F (Typ.) X LED No. (one string);
 - a. V_F: LED chip forward voltage, V_F (Min.)=2.8V, V_F(Typ.)=3.0 V, V_F(Max.)=3.4V
 - b. The same euqation to calculate Vs(Min.) & Vs (Max.) for respective V_F (Min.) & V_F (Max.);



- **Note 4-2:** ΔVs (Max.) = ΔV_F X LED No. (one string);
 - a. $\Delta V_{F:}$ LED chip forward voltage deviation; (0.4V, each Bin of LED V_F)
- **Note 4-3:** P_{BLU} (Typ.) = Vs (Typ.) X Is (Typ.) X 4; (4 is total String No. of LED Light bar) P_{BLU} (Max.) = Vs (Max.) X Is (Typ.) X 4;
- **Note 4-4:** Definition of life time:
 - a. Brightness of LED becomes to 50% of its original value
 - b. Test condition: Is = 50mA and 25 $^{\circ}$ C (Room Temperature)
- Note 4-5: Recommendation for LED driver power design:

 Due to there are electrical property deviation in LED & monitor set system

 component after long time operation. AUO strongly recommend the design value of

 LED driver board OVP (over voltage protection) should be 10% higher than max. value

of LED string voltage (Vs) at least.

- **Note 4-6:** AUO strongly recommend "Analog Dimming" method for backlight brightness control for Wavy Noise Free. Otherwise, recommend that Dimming Control Signal (PWM Signal) should be synchronized with Frame Frequency.
- **Note 4-7:** Ensure that the LED light bar is not subjected either forward or reverse voltage while monitor set is on standby mode or not in use.



5 Reliability Test

AUO reliability test items are listed as following table. (Bare Panel only)

Items	Condition	Remark
Temperature Humidity Bias (THB)	Ta= 50°C, 80%RH, 300hours	
High Temperature Operation (HTO)	Ta= 50°ℂ , 50%RH, 300hours	
Low Temperature Operation (LTO)	Ta= 0°C, 300hours	
High Temperature Storage (HTS)	Ta= 60°ℂ, 300hours	
Low Temperature Storage (LTS)	Ta= -20°ℂ, 300hours	
Vibration Test (Non-operation)	Acceleration: 1.5 Grms Wave: Random Frequency: 10 - 200 Hz Sweep: 30 Minutes each Axis (X, Y, Z)	
Shock Test (Non-operation)	Acceleration: 50 G Wave: Half-sine Active Time: 20 ms Direction: ±X, ±Y, ±Z (one time for each Axis)	
Drop Test	Height: 46 cm, package test	
Thermal Shock Test (TST)	nermal Shock Test (TST) -20°C/30min, 60°C/30min, 100 cycles	
On/Off Test	On/10sec, Off/10sec, 30,000 cycles	
ESD (Electro Statio Discharge)	Contact Discharge: \pm 15KV, 150pF(330 Ω) 1sec, 8 points, 25 times/ point.	Note 5-2
ESD (Electro Static Discharge)	Air Discharge: ± 15KV, 150pF(330Ω) 1sec 8 points, 25 times/ point.	
Altitude Test	Operation:18,000 ft Non-Operation:40,000 ft	

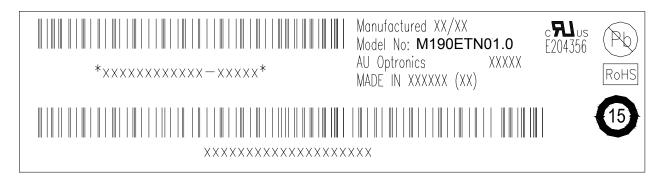
- **Note 5-1**: a. A cycle of rapid temperature change consists of varying the temperature from -20 $^{\circ}$ C to 60 $^{\circ}$ C, and back again. Power is not applied during the test.
 - b. After finish temperature cycling, the unit is placed in normal room ambient for at least 4 hours before power on.

Note 5-2: EN61000-4-2, ESD class B: Certain performance degradation allowed

No data lost Self-recoverable No hardware failures.

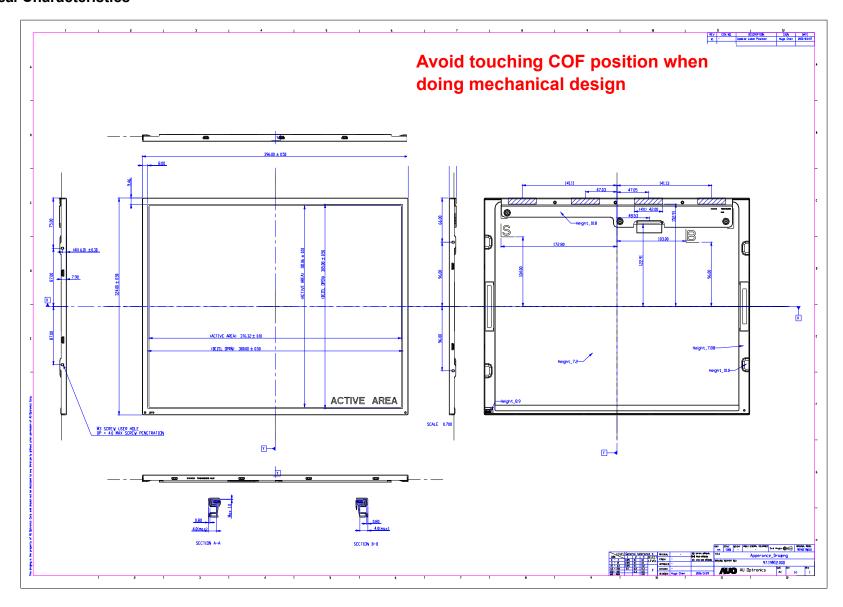
6 Shipping Label

The label is on the panel as shown below:

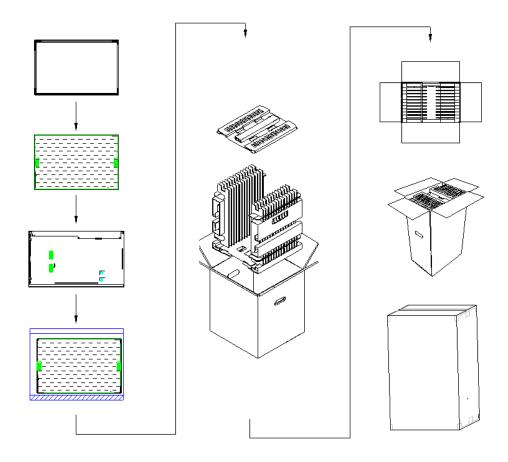


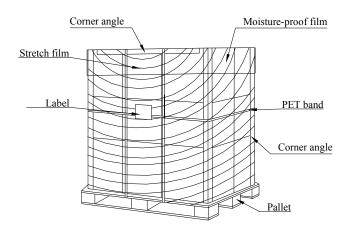
- Note 6-1: For Pb Free products, AUO will add for identification.
- Note 6-2: For RoHS compatible products, AUO will add RoHS for identification.
- Note 6-3: For China RoHS compatible products, AUO will add 6 for identification.
- **Note 6-4:** The Green Mark will be presented only when the green documents have been ready by AUO Internal Green Team.

7 Mechanical Characteristics



8.1 Packing Flow





8.2 Pallet and shipment information

Item		Remark			
Item	Q'ty	Dimension	Weight(kg)	Kemark	
Panel	1	396(H)mm x 324(V)mm x 10.9(D)mm	1.8	Note 1	
Cushion	1		1.85		
Вох	1	409(L)mm x 367(W)mm x 475(H)mm	1.44	without Panel & cushion Note 1	
Packing Box	13 pcs/Box	409(L)mm x 367(W)mm x 475(H)mm	26.83	with panel & cushion Note 1	
Pallet	1	1150(L)mm x 840(W)mm x 132(H)mm	12	Note 1	
Pallet after Packing	18 boxes/pallet	1150(L)mm x 840(W)mm x 156.5(H)mm	492.42	Note 1	

Note 1: Estimated value which is subject to change based on real measured data.